ZZ1  Install label in silkscreened box after final wash. Text shall be 8 pt font. Text shall be per the Label Table in the PDF schematic.
ZZ2  These assemblies are ESD sensitive, ESD precautions shall be observed.
ZZ3  These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.
ZZ4  These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.

**COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.**
**ASSEMBLY VARIANT: 001**

<table>
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<th>PCB VIEWED FROM TOP SIDE</th>
<th>BOARD #: TIDA-01586</th>
<th>REV: E1</th>
<th>SUN REV: Not In VersionControl</th>
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<td>GENERATED</td>
<td>2/2/2018 10:23:40 AM</td>
<td>TEXAS INSTRUMENTS</td>
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COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
ASSEMBLY VARIANT: 001

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<th>PCB VIEWED FROM BOTTOM SIDE</th>
<th>BOARD #: TIDA-01586</th>
<th>REV: E1</th>
<th>SVN REV: Not In VersionControl</th>
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<tr>
<td>PLOT NAME = Bottom Assembly Drawing</td>
<td>TEXAS INSTRUMENTS</td>
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